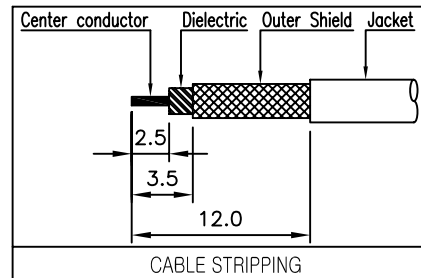
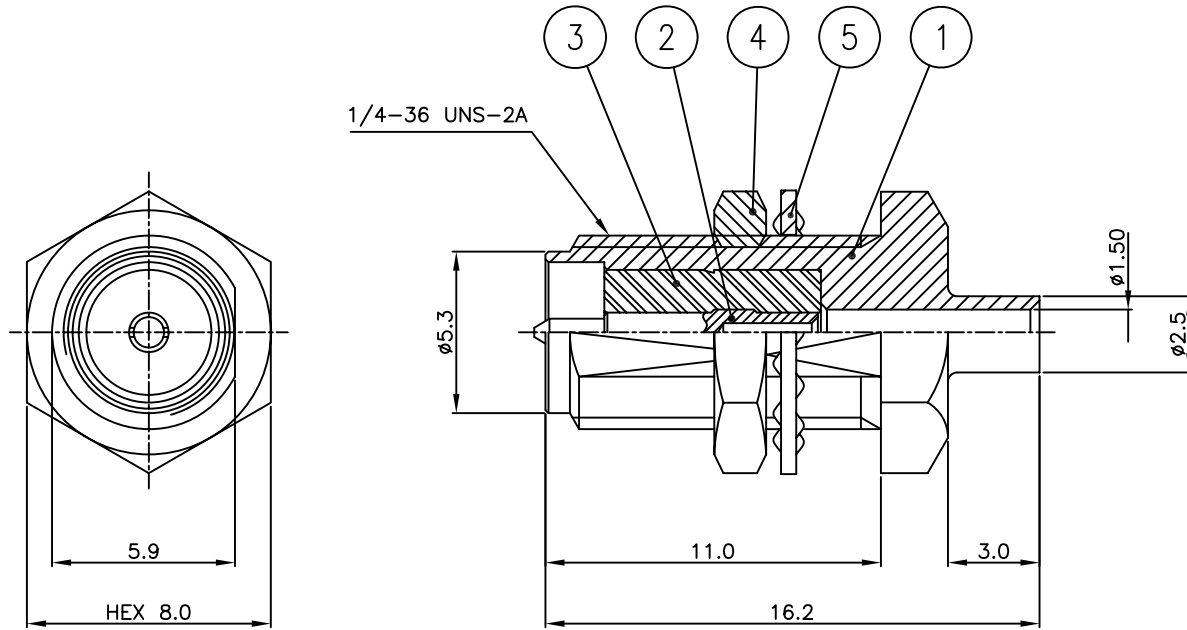


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	M.H.SONG	I.C.KIM	2014. 06. 30.
↑	[설번No.202007-0007] MC CABLE 적용으로 인한 절연체 내경사이즈 변경	S.Y.EUN	I.C.KIM	2020. 07. 28.



5	WASHER	1	BsS	Gold Plate	DWA00005-5/1
4	NUT	1	MBsBD	Gold Plate	DNT00025-5/1
3	INSULATOR	1	TEFLON		DIN02657-N/2 DIN00153-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT03156-5/1
1	BODY	1	MBsBD	Gold Plate	DBD00182-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2020. 07. 28.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	Angle	APPROVED BY	I.C.KIM				
MATERIAL	$\pm 1^{\circ}$	CHECKED BY	TITLE SMA50 CABLE JB (F/N) Reverse MCC $\varnothing 1.33$ (=047)				
	_____	DRAWN BY				S.Y.EUN	
FINISH	_____	SCALE	UNIT	A4	DWG NO.	CN00878-7/3	
	_____	4/1	mm			REVISION	1